

# MAINTENANCE MANUAL

## 30-50 MHz EXCITER BOARD I9D423355G1-G3

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## DESCRIPTION

The exciter uses seven transistors, a crystal module and two integrated circuits to drive the PA assembly. The crystal module determines the (F1) transmitting frequency in single frequency applications. In addition, the exciter also provides temperature compensation voltage to all crystal modules.

In multi-frequency transmitters, the crystal modules for additional frequencies are located on the multi-frequency board.

The crystal frequency ranges from approximately 10.0 to 16.67 megahertz, and is multiplied three times (divided by four and multiplied by 12 for a multiplication factor of three).

Audio, supply voltages and control functions are connected from the system-audio-squelch (SAS) board to the exciter board through P902.

Centralized metering jack J103 is provided for use with GE Test Set Model 4EX3A11 or Test Kit 4EX8K12. The Test Set meters the multipliers, amplifier and the relative power out.

## CIRCUIT ANALYSIS

### OSCILLATOR CIRCUIT

A Colpitts oscillator consisting of Q102, a plug-in crystal module and associated components provides the fundamental operating frequency for the transmitter. The crystal module in the collector base circuit of Q102 is temperature compensated to maintain frequency stability within  $\pm 5$  PPM over an ambient temperature range of  $-30^{\circ}\text{C}$  to  $+60^{\circ}\text{C}$ . Compensation voltage is applied from compensator circuit Q101. The output of the oscillator is taken from the collector of Q102, buffered by Q103 and applied to frequency divider U102.

### SERVICE NOTE

Y1 and C2 are not field replaceable items. C2 is factory selected to complement the temperature/frequency characteristics of each individual crystal. Should it become necessary to replace either Y1 or C2, the entire crystal module must be replaced.

In single frequency radios, the F1 keying lead is connected directly to A- by a DA jumper connected between H12 and H31 on the SAS board. This assures F1 oscillator operation each time the PTT switch is pressed. When the PTT switch is operated, +10 Volts is present on the transmitter oscillator lead at P902-1 and the emitter of Q102. R104 and R105 form a voltage divider network to establish the base voltage for Q102.

In multi-frequency radios the jumper connected between H12 and H31 is removed to allow F1 frequency selection via the frequency selector switch on the control unit.

When frequencies F2 thru F4 are selected the oscillator frequency from the multi-frequency board is supplied to J102-1 on the exciter through cable W2601.

### COMPENSATOR CIRCUITS

The crystal modules are temperature compensated at both ends of the temperature range to provide instant frequency compensation. The temperature compensator consists of Q101, VR102, RT101, RT102 and associated components. Zener diode VR102 provides a constant +8.5 V reference voltage for compensator Q101.

The cold end compensation circuit does not operate at temperatures above  $-10^{\circ}\text{C}$  ( $+14^{\circ}\text{F}$ ). When the temperature drops below  $-10^{\circ}\text{C}$ , the circuit is activated. As the temperature decreases, the resistance of

RT101 increases and the compensation voltage increases.

An increase in compensation voltage decreases the capacitance of the varactor in the oscillator, thereby increasing the output frequency of the crystal module.

The hot end compensation circuit does not operate at temperatures below +50°C (122°F). When the temperature rises above +50°C, the circuit is activated. As the temperature increases, the resistance of RT102 decreases and the compensation voltage decreases. The decrease in compensation voltage increases the capacity of the varactor, decreasing the output frequency of the crystal module.

Listed below are typical minimum and maximum voltage readings to be expected at pin 4 of the crystal modules. Voltages should be measured using a high impedance meter.

TEMPERATURE RANGE	OUTPUT VOLTAGE	
	MINIMUM	MAXIMUM
-30°C	4.9 Volts	6.0 Volts
-10°C to 50°C	3.7 Volts	4.3 Volts
+75°C	3.3 Volts	3.8 Volts

#### AUDIO IC

The transmitter audio circuitry is contained in audio IC U101. A simplified drawing of the audio IC is shown in Figure 1.

Audio from the microphone at pin 12 is coupled through pre-emphasis capacitor C1 to the base of Q1 in the operational amplifier-

limiter circuit. Collector voltage for the transistorized microphone pre-amplifier is supplied from the 10-volt regulator on the SAS board through R979 & R980 to J901A-14 in MASTR® Executive II radios.

In Custom MVP radios, collector voltage for the transistorized microphone pre-amplifier is supplied from the 10-Volt regulator on the SAS board through R928, R929 and J913 to the microphone.

The operational amplifier-limiter circuit consists of Q1, Q2 and Q3. Q3 provides limiting at high signal levels. The gain of the operational amplifier circuit is fixed by negative feedback through R19, R20 and the resistance in the network (Pin 9).

The output of Q3 is coupled through a de-emphasis network (R10 and C3) to an active post-limiter filter consisting of C4, C5, C6, R11, R12, R13, R15, R17 and Q4.

Following the post-limiter filter is Class A amplifier Q5. The output of Q5 is coupled through MOD ADJUST potentiometer R108 and resistor R119 to the phase modulators.

**SERVICE NOTE:** If the DC voltages applied to the audio IC are correct and there is no audio output, replace U101.

For radios equipped with Channel Guard, tone from the encoder is applied to the phase modulators through P902-9, (CG H1) and resistors R117 and R121. Instructions for setting Channel Guard modulation are located in the Transmitter Alignment procedures.

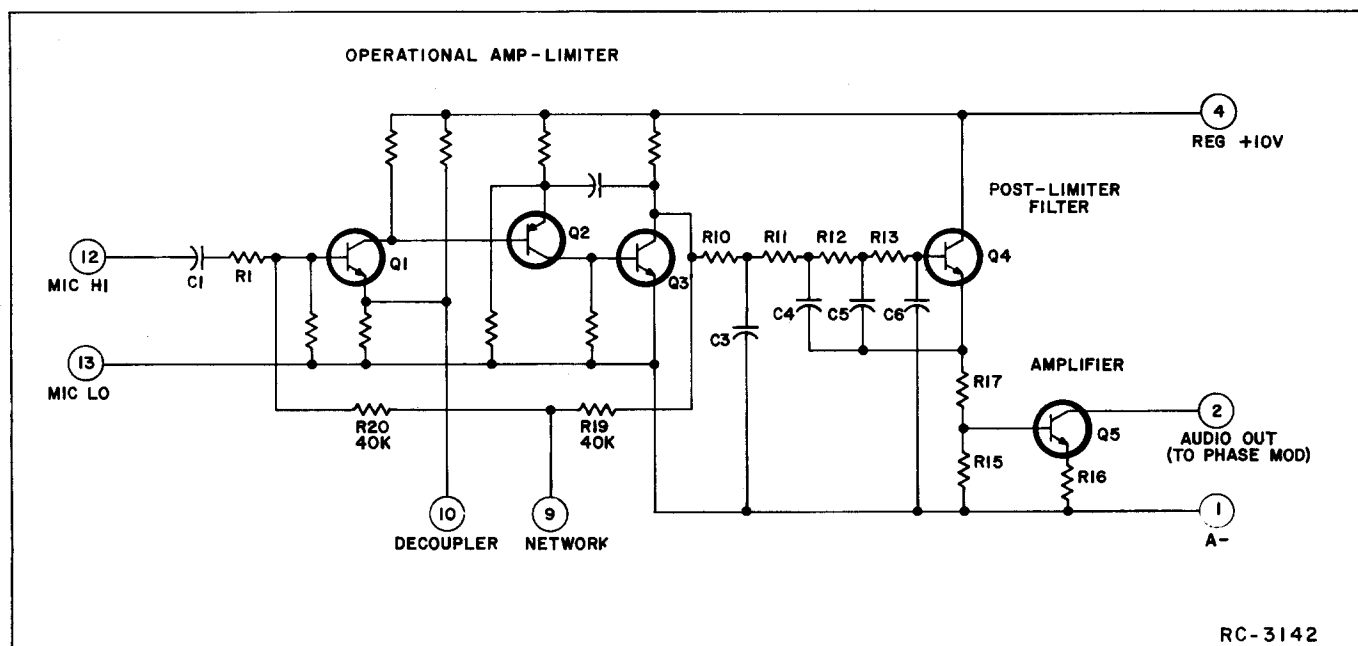


Figure 1 - Simplified Audio IC

## FREQUENCY DIVIDER IC

The output at pin 3 of the selected crystal module is coupled through buffer amplifier Q103 to frequency divider U102. U102 divides the oscillator frequency by 4. The divider consists of two J-K flip-flops connected as a binary counter.

When the transmitter is not keyed (no crystal modules on), Q103 is saturated (turned on) with its collector voltage near zero. Keying the transmitter starts one of the crystal modules and its output turns Q103 off and on once each cycle. As Q103 turns on during each cycle, the drop in collector voltage causes the left flip-flop to change state. Assume the flip-flop was in the "0" state (the output at "Q" near A-). The first cycle of the oscillator output causes it to switch to the "1" state (output at "Q" approximately 5 Volts). The second cycle will cause the flip-flop to switch back to the "0" state. Therefore, it requires two oscillator cycles to switch the left flip-flop through one complete cycle from "0" to "1" and back to "0".

When the left flip-flop switches from "1" to "0", it causes the right flip-flop to change state. It requires two cycles of the left flip-flop to switch the right flip-flop from "0" to "1" and back to "0". Therefore, four cycles of the oscillator output are required for each cycle of output from pin 9 of U102.

If U102 was operating into a pure resistive load, its output would be a square wave. However, the modulator circuit presents a tuned load to the IC, so that harmonics are filtered out and the waveform at the junction of C117 and C118 (modulator input) is essentially a sine wave at one-fourth the oscillator frequency. The output of the frequency divider is coupled through DC blocking capacitor C117 to the first modulator stage.

## BUFFER &amp; PHASE MODULATOR

The divider output is coupled to the first phase modulator. The first phase modulator is varactor (voltage-variable capacitor) CR101 in series with tunable coil L101. This network appears as a series-resonant circuit to the RF output of the oscillator. An audio signal applied to the modulator circuit through blocking capacitor C115 varies the bias of CR101 and CR102 resulting in a phase modulated output. A voltage divider network (R110 and R113) provides the proper bias for varactors CR101 and CR102.

The output of the modulator is coupled through blocking capacitor C120 to the base of buffer Q104.

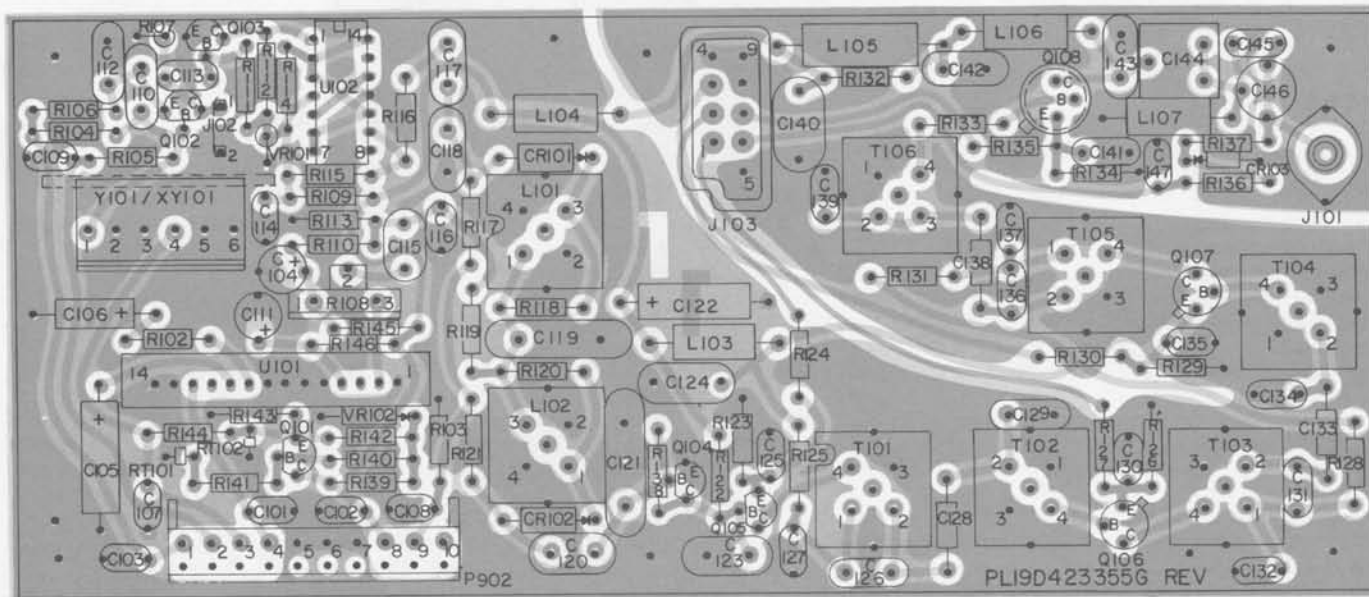
## MULTIPLIERS &amp; AMPLIFIER

Buffer Q104 is saturated when no RF signal is present. Applying an RF signal to Q104 provides a sawtooth waveform at its collector to drive class C tripler, Q105. The tripler stage is metered through R124. The output of Q105 is coupled through tuned circuits T101 and T102 to the base of doubler Q106. T101 and T102 are tuned to one-fourth of the operating frequency. The doubler stage is metered through R127.

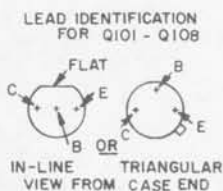
The output of Q106 is coupled through tuned circuits T103 and T104 to the base of second doubler Q107. T103 and T104 are tuned to one-half the operating frequency. Q107 is metered through R130.

The output of Q107 is coupled through two tuned circuits (T105 and T106) to the base of amplifier Q108. These circuits are tuned to the transmitter operating frequency.

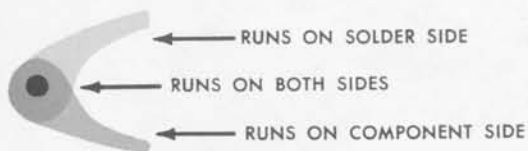
Q108 is a class C amplifier and is metered through R135. The amplifier collector circuit consists of L107 and C143 through C146 and matches the amplifier output to the input of the power amplifier assembly. The exciter provides a minimum of 250 milliwatts of RF power to the power amplifier through J101 and cable W216. The relative power output is metered through a metering circuit consisting of C147, CR103, R136 and R137.



(19C327179, Rev. 0)  
 (19D423331, Sh. 2, Rev. 1)  
 (19D423331, Sh. 3, Rev. 1)

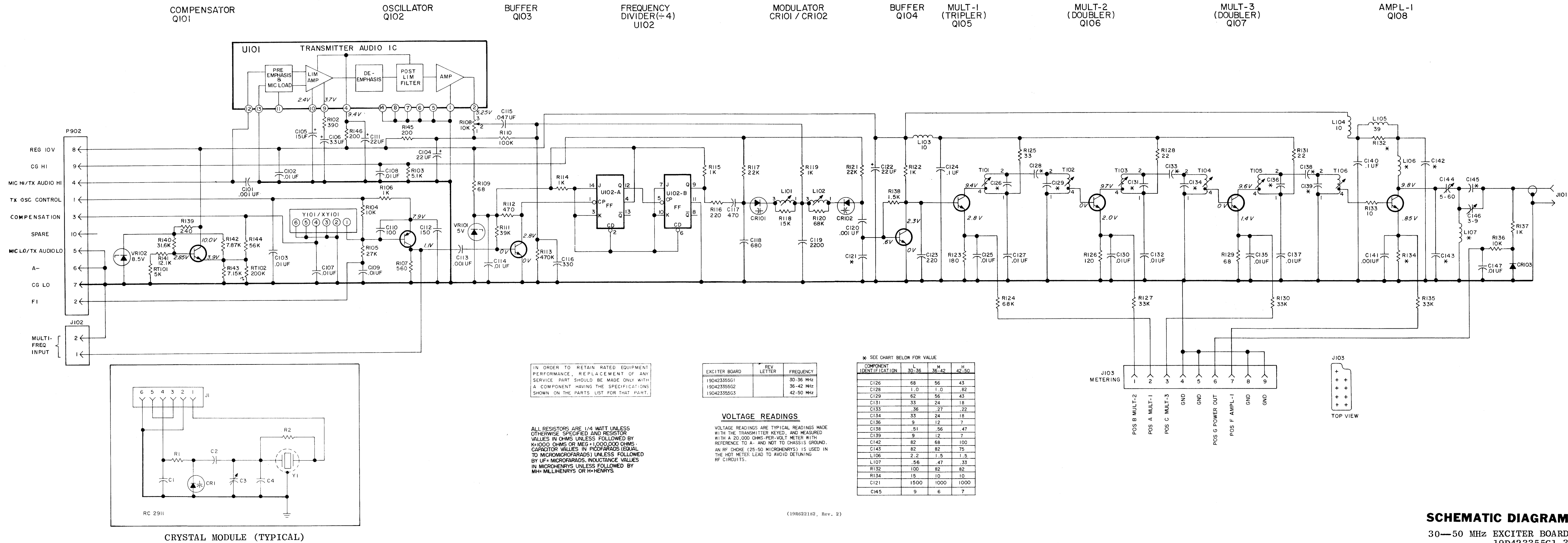


NOTE:  
 1. COLOR DOT ON BASE OF COIL IDENTIFIES PIN 1 ON L101, L102 AND T101 - T106.



## OUTLINE DIAGRAM

30—50 MHz EXCITER BOARD  
 19D423355G1-3



**SCHEMATIC DIAGRAM**  
30—50 MHz EXCITER BOARD  
19D423355G1-3

PARTS LIST		
LBI-30093		
EXCITER BOARD		
19D423355G1 30-36 MHz		
19D423355G2 36-42 MHz		
19D423355G3 42-50 MHz		
SYMBOL	GE PART NO.	DESCRIPTION
- - - - - CAPACITORS - - - - -		
C101	19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C102 and C103	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
C104	19A134202P6	Tantalum: 22 µf ±20%, 15 VDCW.
C105	5496267P14	Tantalum: 15 µf ±20%, 20 VDCW; sim to Sprague Type 150D.
C106	5496267P9	Tantalum: 3.3 µf ±20%, 15 VDCW; sim to Sprague Type 150D.
C107 and C108	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
C109	19A116080P101	Polyester: 0.01 µf ±10%, 50 VDCW.
C110	19A116656P100J7	Ceramic disc: 100 pf ±5%, 500 VDCW, temp coef -750 PPM.
C111	19A134202P6	Tantalum: 22 µf ±20%, 15 VDCW.
C112	7489162P31	Silver mica: 150 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C113	19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C114	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
C115	19A116080P105	Polyester: 0.047 µf ±10%, 50 VDCW.
C116	5494481P105	Ceramic disc: 330 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C117	5490008P43	Silver mica: 470 pf ±5%, 300 VDCW; sim to Electro Motive Type DM-15.
C118	5493366P680J	Mica: 680 pf ±5%, 100 VDCW; sim to Electro Motive Type DM-15.
C119	4029003P116	Silver mica: 2200 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-20.
C120	5493366P1000J	Mica: 1000 pf ±5%, 100 VDCW; sim to Electro Motive Type DM-15.
C121L	4029003P112	Silver mica: 1500 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-20.
C121M	5493366P1000J	Mica: 1000 pf ±5%, 100 VDCW; sim to Electro Motive Type DM-15.
C121H	5493366P1000J	Mica: 1000 pf ±5%, 100 VDCW; sim to Electro Motive Type DM-15.
C122	5496267P10	Tantalum: 22 µf ±20%, 15 VDCW; sim to Sprague Type 150D.
C123	5490008P135	Silver mica: 220 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15.
C124	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C125	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
C126L	5496219P359	Ceramic disc: 68 pf ±5%, 500 VDCW, temp coef -150 PPM.
C126M	5496219P257	Ceramic disc: 56 pf ±5%, 500 VDCW, temp coef -80 PPM.
C126H	5496219P254	Ceramic disc: 43 pf ±5%, 500 VDCW, temp coef -80 PPM.
C127	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
C128L	5491601P120	Phenolic: 1.0 pf ±5%, 500 VDCW.
C128M	5491601P120	Phenolic: 1.0 pf ±5%, 500 VDCW.
C128H	5491601P119	Phenolic: 0.82 pf ±5%, 500 VDCW.
C129L	5496219P258	Ceramic disc: 62 pf ±5%, 500 VDCW, temp coef -80 PPM.

SYMBOL	GE PART NO.	DESCRIPTION
C129M	5496219P257	Ceramic disc: 56 pf ±5%, 500 VDCW, temp coef -80 PPM.
C129H	5496219P254	Ceramic disc: 43 pf ±5%, 500 VDCW, temp coef -80 PPM.
C130	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
C131L	5496219P251	Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -80 PPM.
C131M	5496219P248	Ceramic disc: 24 pf ±5%, 500 VDCW, temp coef -80 PPM.
C131H	5496219P245	Ceramic disc: 18 pf ±5%, 500 VDCW, temp coef -80 PPM.
C132	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
C133L	5491601P110	Phenolic: 0.36 pf ±5%, 500 VDCW.
C133M	5491601P107	Phenolic: 0.27 pf ±5%, 500 VDCW.
C133H	5491601P105	Phenolic: 0.22 pf ±5%, 500 VDCW.
C134L	5496219P251	Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -80 PPM.
C134M	5496219P248	Ceramic disc: 24 pf ±5%, 500 VDCW, temp coef -80 PPM.
C134H	5496219P245	Ceramic disc: 18 pf ±5%, 500 VDCW, temp coef -80 PPM.
C135	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
C136L	5496219P240	Ceramic disc: 9.0 pf ±0.25 pf, 500 VDCW, temp coef -80 PPM.
C136M	5496219P242	Ceramic disc: 12 pf ±5%, 500 VDCW, temp coef -80 PPM.
C136H	5496219P238	Ceramic disc: 7.0 pf ±0.25 pf, 500 VDCW, temp coef -80 PPM.
C137	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
C138L	5491601P114	Phenolic: 0.51 pf ±5%, 500 VDCW.
C138M	5491601P115	Phenolic: 0.56 pf ±5%, 500 VDCW.
C138H	5491601P113	Phenolic: 0.47 pf ±5%, 500 VDCW.
C139L	5496219P240	Ceramic disc: 9.0 pf ±0.25 pf, 500 VDCW, temp coef -80 PPM.
C139M	5496219P242	Ceramic disc: 12 pf ±5%, 500 VDCW, temp coef -80 PPM.
C139H	5496219P238	Ceramic disc: 7.0 pf ±0.25 pf, 500 VDCW, temp coef -80 PPM.
C140	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C141	19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C142L	5490008P125	Silver mica: 82 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15.
C142M	5490008P123	Silver mica: 68 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15.
C142H	5490008P127	Silver mica: 100 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15.
C143L	5490008P25	Silver mica: 82 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C143M	5490008P25	Silver mica: 82 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C143H	5490008P24	Silver mica: 75 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C144	19A116163P5	Variable: approx 5 to 60 pf, 50 VDCW; sim to Amperex 2222-609-08003.
C145L	5496219P240	Ceramic disc: 9.0 pf ±0.25 pf, 500 VDCW, temp coef -80 PPM.
C145M	5496219P237	Ceramic disc: 6.0 pf ±0.25 pf, 500 VDCW, temp coef -80 PPM.
C145H	5496219P238	Ceramic disc: 7.0 pf ±0.25 pf, 500 VDCW, temp coef -80 PPM.
C146	19A116867P2	Variable: 3-9 pf, 160 VDCW; sim to 7-S-TRIKO-02.
C147	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
- - - - - DIODES AND RECTIFIERS - - - - -		
CR101 and CR102	5495769P12	Diode, silicon.
CR103	19A115250P1	Silicon.

SYMBOL	GE PART NO.	DESCRIPTION
J101	19A130924G1	Connector: coaxial: jack type; sim to Cinch 14H11613.
J102	19A116779P1	Contact, electrical: sim to Molex 08-50-0404. (Quantity 2).
J103	19B219374G1	Connector: 9 contacts.
- - - - - INDUCTORS - - - - -		
L101L	19D416635G17	Coil. Includes: 5493185P8
L101M	19D416635G1	Coil. Includes: 5493185P8
L101H	19D416635G18	Coil. Includes: 5493185P8
L102L	19D416635G17	Coil. Includes: 5493185P8
L102M	19D416635G1	Coil. Includes: 5493185P8
L102H	19D416635G18	Coil. Includes: 5493185P8
L103 and L104	7488079P16	Choke, RF: 10.0 µh ±10%, 0.60 ohms DC res max; sim to Jeffers 4421-7.
L105	7488079P50	Choke, RF: 39.0 µh ±10%, 2.00 ohms DC res max; sim to Jeffers 4422-11.
L106L	7488079P8	Choke, RF: 2.20 µh ±10%, 1.00 ohms DC res max; sim to Jeffers 4411-12.
L106M	7488079P7	Choke, RF: 1.50 µh ±10%, 0.50 ohms DC res max; sim to Jeffers 4411-10.
L106H	7488079P7	Choke, RF: 1.50 µh ±10%, 0.50 ohms DC res max; sim to Jeffers 4411-10.
L107L	7488079P75	Choke, RF: 0.56 µh ±10%, 0.125 ohms DC res max; sim to Jeffers 4411-5.
L107M	7488079P4	Choke, RF: 0.47 µh ±20%, 0.09 ohms DC res max; sim to Jeffers 4411-4.
L107H	7488079P3	Choke, RF: 0.33 µh ±20%, 0.07 ohms DC res max; sim to Jeffers 4411-3.
- - - - - PLUGS - - - - -		
P902	19A116659P2	Connector, printed wiring: 10 contacts; sim to Molex 09-52-3102.
- - - - - TRANSISTORS - - - - -		
Q101	19A116774P1	Silicon, NPN; sim to Type 2N5210.
Q102	19A115852P1	Silicon, PNP; sim to Type 2N3906.
Q103	19A115910P1	Silicon, NPN; sim to Type 2N3904.
Q104 and Q105	19A115330P1	Silicon, NPN.
Q106 and Q107	19A115328P1	Silicon, NPN.
Q108	19A115329P2	Silicon, NPN.
- - - - - RESISTORS - - - - -		
R102	3R152P391K	Composition: 390 ohms ±10%, 1/4 w.
R103	3R152P512J	Composition: 5100 ohms ±5%, 1/4 w.
R104	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.
R105	3R152P273J	Composition: 27,000 ohms ±5%, 1/4 w.
R106	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
R107	3R152P561J	Composition: 560 ohms ±5%, 1/4 w.
R108	19B209358P106	Variable, carbon film: approx 300 to 10,000 ohms ±10%, 0.25 w; sim to CTS Type X-201.
R109	3R152P680K	Composition: 68 ohms ±10%, 1/4 w.

SYMBOL	GE PART NO.	DESCRIPTION
R110	3R152P104K	Composition: 0.10 megohm ±10%, 1/4 w.
R111	3R152P393K	Composition: 39,000 ohms ±10%, 1/4 w.
R112	3R152P471K	Composition: 470 ohms ±10%, 1/4 w.
R113	3R152P474K	Composition: 0.47 megohm ±10%, 1/4 w.
R114 and R115	3R152P102K	Composition: 1000 ohms ±10%, 1/4 w.
R116	3R152P221K	Composition: 220 ohms ±10%, 1/4 w.
R117	3R152P223K	Composition: 22,000 ohms ±10%, 1/4 w.
R118	3R152P153K	Composition: 15,000 ohms ±10%, 1/4 w.
R119	3R152P102K	Composition: 1000 ohms ±10%, 1/4 w.
R120	3R152P683K	Composition: 68,000 ohms ±10%, 1/4 w.
R121	3R152P223K	Composition: 22,000 ohms ±10%, 1/4 w.
R122	3R152P102K	Composition: 1000 ohms ±10%, 1/4 w.
R123	3R152P181K	Composition: 180 ohms ±10%, 1/4 w.
R124	3R152P683K	Composition: 68,000 ohms ±10%, 1/4 w.
R125	3R152P330K	Composition: 33 ohms ±10%, 1/4 w.
R126	3R152P121K	Composition: 120 ohms ±10%, 1/4 w.
R127	3R152P333K	Composition: 33,000 ohms ±10%, 1/4 w.
R128	3R152P220K	Composition: 22 ohms ±10%, 1/4 w.
R129	3R152P680K	Composition: 68 ohms ±10%, 1/4 w.
R130	3R152P333K	Composition: 33,000 ohms ±10%, 1/4 w.
R131	3R152P220K	Composition: 22 ohms ±10%, 1/4 w.
R132L	3R152P101K	Composition: 100 ohms ±10%, 1/4 w.
R132M	3R152P820K	Composition: 82 ohms ±10%, 1/4 w.
R132H	3R152P820K	Composition: 82 ohms ±10%, 1/4 w.
R133	3R152P100K	Composition: 10 ohms ±10%, 1/4 w.
R134L	3R152P150K	Composition: 15 ohms ±10%, 1/4 w.
R134M	3R152P100K	Composition: 10 ohms ±10%, 1/4 w.
R134H	3R152P100K	Composition: 10 ohms ±10%, 1/4 w.
R135	3R152P333K	Composition: 33,000 ohms ±10%, 1/4 w.
R136	3R152P103K	Composition: 10,000 ohms ±10%, 1/4 w.
R137	3R152P102K	Composition: 1000 ohms ±10%, 1/4 w.
R138	3R152P152K	Composition: 1500 ohms ±10%, 1/4 w.
R139	3R152P241J	Composition: 240 ohms ±5%, 1/4 w.
R140	19C314256P23162	Metal film: 31,600 ohms ±1%, 1/4 w.
R141	19C314256P21212	Metal film: 12,100 ohms ±1%, 1/4 w.
R142	19C314256P27871	Metal film: 7870 ohms ±1%, 1/4 w.
R143	19C314256P27151	Metal film: 7150 ohms ±1%, 1/4 w.
R144	3R152P563K	Composition: 56,000 ohms ±10%, 1/4 w.
R145 and R146	3R152P201J	Composition: 200 ohms ±5%, 1/4 w.
- - - - - THERMISTORS - - - - -		
RT101	19C300048P7	Disc: 5000 ohms ±10%; sim to NL 1D103.
RT102	19C300048P5	Disc: 200,000 ohms ±10%; sim to NL 4D051.
- - - - - TRANSFORMERS - - - - -		
T101L	19D416635G10	Coil. Includes: 5493185P13
T101M	19D416635G2	Coil. Includes: 5493185P13
T101H	19D416635G2	Coil. Includes: 5493185P13
T102L	19D416635G12	Coil. Includes: 5493185P13

SYMBOL	GE PART NO.	DESCRIPTION
T102M	19D416635G4	Coil. Includes: 5493185P13
T102H	19D416635G4	Coil. Includes: 5493185P13
T103L	19D416635G13	Coil. Includes: 5493185P13
T103M	19D416635G5	Coil. Includes: 5493185P13
T103H	19D416635G5	Coil. Includes: 5493185P13
T104L	19D416635G13	Coil. Includes: 5493185P13
T104M	19D416635G5	Coil. Includes: 5493185P13
T104H	19D416635G5	Coil. Includes: 5493185P13
T105L	19D416635G14	Coil. Includes: 5493185P13
T105M	19D416635G6	Coil. Includes: 5493185P13
T105H	19D416635G6	Coil. Includes: 5493185P13
T106L	19D416635G16	Coil. Includes: 5493185P13
T106M	19D416635G8	Coil. Includes: 5493185P13
T106H	19D416635G8	Coil. Includes: 5493185P13
- - - - - INTEGRATED CIRCUITS - - - - -		
U101	19D416542G2	Transmitter, Audio.
U102	19A116842P1	Digital, High Speed TTL: Dual J-K Master-Slave Flip Flop; sim to SM54H73N.
- - - - - VOLTAGE REGULATORS - - - - -		
VR101	4036887P56	Silicon, Zener.
VR102	4036887P9	Silicon, Zener.
- - - - - SOCKETS - - - - -		
XY101	19A116659P50	Connector, printed wiring: 6 contacts; sim to Molex 09-65-1061.
- - - - - CRYSTAL MODULES - - - - -		
NOTE: When reordering, give GE Part Number and specify exact operating frequency needed.		
Y101	19B226962G1	Crystal module: 5 PPM, 30-36 MHz.
	19B226962G2	Crystal module: 5 PPM, 36-42 MHz.
	19B226962G3	Crystal module: 5 PPM, 42-50 MHz.
- - - - - MISCELLANEOUS - - - - -		
	19A129424G2	Can. (Used with L101, L102, T101-T106).
	4036555P1	Insulator, washer: nylon. (Used with Q108).